PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q80670

Akiko MATSUMURA, et al.

Appln. No.: Unknown

Confirmation No.: Not yet assigned

Group Art Unit: Not yet assigned

Filed: March 25, 2004

Examiner: Not yet assigned

For:

ADHESIVE FILM FOR UNDERFILL AND SEMICONDUCTOR DEVICE USING

THE SAME

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §§ 1.97 and 1.98

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure under 37 C.F.R. § 1.56, Applicant hereby notifies the U.S. Patent and Trademark Office of the documents which are listed on the attached PTO/SB/08 A & B (modified) form and/or listed herein and which the Examiner may deem material to patentability of the claims of the above-identified application.

One copy of each of the listed documents, other than any U.S. patents and patent publications, is submitted herewith.

The present Information Disclosure Statement is being filed: (1) No later than three months from the application's filing date; (2) Before the mailing date of the first Office Action on the merits (whichever is later); or (3) Before the mailing date of the first Office Action after filing a request for continued examination (RCE) under §1.114, and therefore, no Statement under 37 C.F.R. § 1.97(e) or fee under 37 C.F.R. § 1.17(p) is required.

INFORMATION DISCLOSURE STATEMENT Attorney Docket No.: Q80670

In compliance with the concise explanation requirement under 37 C.F.R. § 1.98(a)(3) for foreign language documents, Applicant submits the following explanations: Though polycarbodiimide resins are thermosetting resins having excellent heat resistance, they are slightly soluble in various solvents and have low fluidity when melted, so that their mold processing becomes difficult in their practical use. With the aim of improving mold processing ability of such a polycarbodiimide, JP-A-51-61599, JP-A-61-246245, JP-A-4-261428 and the like disclose preparation of a powdery polycarbodiimide using 4,4'-diphenylmethane diisocyanate (MDI hereinafter) and a monoisocyanate. Though such a polycarbodiimide can be molded into a sheet shape by hot pressing, its workability cannot be said high and the moldings are hard and poor in flexibility.

Also, JP-A-2-292316 and JP-A-5-310877 describe a method for producing a polycarbodiimide solution using a specified solvent in carrying out polymerization from tolylene diisocyanate (TDI hereinafter). Though there are descriptions therein stating that the moldability is improved, flexibility of the hardened products is lower than that of the polycarbodiimide obtained from 4,4'-diphenylmethane diisocyanate.

In addition, JP-A-11-322888 and US Patent 5,357,021 disclose that

flexibility of a polycarbodiimide is improved by introducing a long chain polyether or a long chain polyester into its molecule through urethane bond, urea bond or the like.

However, heat resistance of the polycarbodiimide is sharply reduced by such a modification.

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The submission of the listed documents is not intended as an admission that any such document constitutes prior art against the claims of the present application. Applicant does not waive any right to take any action that would be appropriate to antedate or otherwise

remove any listed document as a competent reference against the claims of the present

application.

The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this paper is attached.

Respectfully submitted,

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WASHINGTON OFFICE 23373 CUSTOMER NUMBER

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Date: March 25, 2004

Substitute for Form 1449 A & B/PTO				Complete if Known		
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INFO	RMATION	DISCLOS	SURE	Confirmation Number	Not yet assigned	
STATEMENT BY APPLICANT				Filing Date	March 25, 2004	
<u> </u>				First Named Inventor	Akiko MATSUMURA, et al.	
(use	e as many sheet	ts as necessa	ry)	Art Unit	Not yet assigned	
,			•	Examiner Name	Not yet assigned	
Sheet	1	of	1	Attorney Docket Number	Q80670	

U.S. PATENT DOCUMENTS						
	-	Document N	Number	Publication Date MM-DD-YYYY		
	Cite No.1	Number	Kind Code ² (if known)		Name of Patentee or Applicant of Cited Docume	
		US 5,357,021	Α	10/18/1994	Anthony J. TYE, et al.	
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FOREIGN PATENT DOCUMENTS							
Examiner Cite Initials* No.1	Foreign Patent Document			Publication Date	Name of Patentee or		
	Country Code ³	Number ⁴	Kind Code ⁵ (if known)	MM-DD-YYYY	Applicant of Cited Document	Translation ⁶	
		JP	51-61599		05/28/1796		
		JР	61-246245	A	11/01/1986		
		JP	4-261428	A	09/17/1992		
		JP	2-292316	A	12/03/1990		
		JР	5-310877	A	11/22/1993		
		JP	11-322888	A	11/26/1999		
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		NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation
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Examiner Signature	Date Considered	

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Applicant's unique citation designation number (optional). ²See Kind Codes of USPTO Patent Documents at www.uspto.gov, MPEP 901.04 or follow the hyperlink from the title of the document to the intranet. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to indicate here if English language Translation is attached.